

uDiskOnChip (uDOC)

Modular Flash Disk with USB 2.0 Interface

Data Sheet, November 2006

Highlights

The performance of embedded systems in markets such as Single Board Computers (SBCs), thin clients, consumer electronics, Point Of Sale (POS) and telecom, is limited by IDE-based flash disks. A combination of higher capacity, higher performance devices is needed to support larger OSs, heavier GUI applications, a wide variety of installed applications and local data storage. uDiskOnChip (uDOC) answers these needs by merging M-Systems' expertise in three worlds: the USB 2.0 high-speed interface, the DiskOnChip industry-standard flash for embedded systems, and the SuperMAP™ cryptographic engine.

uDiskOnChip features:

- Exceptional read, write, and erase performance
- Built-in proprietary TrueFFS® technology for full hard-disk emulation, high data reliability, and maximum flash lifetime
- Data integrity with Error Detection Code/Error Correction Code (EDC/ECC) based on a combination of BCH and Hamming algorithms
- Support for major embedded OSs, including Windows XP Embedded and Linux

Protection and Security Features

- SuperMAP cryptographic engine to enable protected partitions
- Data protected in hardware with digital signature: RSA with 64-byte key



Performance

	Number of Flash Chips	USB 2.0 High-Speed
Sustained Read	2	20 MByte/sec
Sustained Write	2	10 MByte/sec
Sustained Read	1	13 MByte/sec
Sustained Write	1	7 MByte/sec

- USB 2.0: 480 Mbit/sec high-speed USB compatible
- USB 1.1
 - 12 Mbit/sec full-speed USB compatible
 - Sustained Read rate: 1 MB/sec
 - Sustained Write rate: 0.85 MB/sec
- Flash Interleave and Fly-By™ algorithm for improved performance

Data Reliability

- 4-bit Error Detection Code/Error Correction Code (EDC/ECC), based on a patented combination of BCH and Hamming code algorithms
- Guaranteed data integrity even after power loss
- Transparent bad-block management
- Dynamic and static wear-leveling
- Wear leveling algorithm that provides more than **5 million** write/erase cycles for reliable data storage over an extended period

Operating Environment

- Any BIOS supporting boot from USB Mass Storage Class devices
- Can be used for boot and/or storage on the following operating systems:
 - Windows XP Embedded
 - Windows CE
 - Windows Embedded for Point of Service (WEPOS)
 - Linux
 - VxWorks (storage only)

Power Requirements

- Power supply: 5VDC±10%
- Power consumption ($V_{cc}=5V$):
 - Read/Write: 100 mA (typ)
 - Suspend: <500 μA

Form Factors

- Horizontal alignment with mounting hole
- Horizontal alignment with 1x5 mechanical connector
- Low profile with mounting hole

RoHS Support

- RoHS version available (all configurations)

Environmental

- Operating temperature:
 - Commercial: 0°C to +70°C
 - Extended: -40°C to +85°C
- Storage temperature: -55°C to +95°C

Capacities

- 32MB – 4GB

Applications

- Embedded systems
- Single-board computers, Extended PCs
- Thin clients, network computers
- Set-top boxes
- Medical equipment
- Gaming

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1. INTRODUCTION

This data sheet includes the following sections:

- Section 1:** Overview of data sheet contents
- Section 2:** Product overview, including brief product description, interface diagram and header/connector descriptions
- Section 3:** Theory of operation for the major building blocks
- Section 4:** Description of TrueFFS technology
- Section 5:** Environmental, mechanical and electrical specifications
- Section 6:** Description of the available software components
- Section 7:** Ordering information for uDiskOnChip

For additional information on M-Systems' flash disk products, please contact one of the offices listed on the back page.

2. PRODUCT OVERVIEW

2.1 Product Description

uDiskOnChip (uDOC) is the ideal data storage device in any USB-capable system, capitalizing on M-Systems' expertise in three fields: The USB interface (based on its USB flash drive), flash drives for the embedded market (based on the DiskOnChip product line), and security (based on patented algorithms).

uDiskOnChip offers the speed and ease of the USB interface. uDiskOnChip can work with any operating system that supports USB Mass Storage Class devices, such as Windows XP Embedded, Windows CE, Linux, and others.

M-Systems' patented TrueFFS flash management technology, which fully emulates a hard disk in DiskOnChip products, is embedded in the uDiskOnChip firmware to streamline integration efforts. This transparent file system management enables read/write operations that are identical to a standard, sector-based hard disk. In addition, TrueFFS employs patented methods, such as virtual mapping, dynamic and static wear-leveling, and automatic block management to ensure high data reliability and to maximize flash life expectancy. Data integrity is guaranteed through an embedded 4-bit error detection and error correction code algorithm that automatically detects and corrects data errors. The EDC/ECC algorithm is based on a combination of Hamming and BCH code.

uDiskOnChip provides data protection in hardware, utilizing RSA with a 64-byte key. This feature is enabled by the SuperMAP cryptographic engine developed by M-Systems' Fortress division and used successfully in thousands of smartcards.

uDiskOnChip is based on Single Level Cell (SLC) NAND flash technology. This technology is superior in its data storage characteristics, featuring the industry's highest performance. Additionally, NAND flash technology is known for its high density and small die size, with the related cost and real estate benefits. Multi-Level Cell (MLC) NAND is planned for use in the next-generation product, enabling further cost benefits.

uDiskOnChip is available in capacities ranging from 32MB to 4GB with a fast and simple upgrade path. It fits easily into any platform with an embedded USB connector, and can be secured firmly into place for enhanced ruggedness.

2.2 2x5 Electrical Interface

uDiskOnChip is available in a horizontal version with a 2x5-pin electrical interface. uDiskOnChip provides two configurations; a 2x5 electrical interface plus mounting hole, and a 2x5 electrical interface plus 1x5 mechanical interface.

2.2.1 Standard On-Board USB Header

Table 1 lists the host interface on-board header pins and signals.

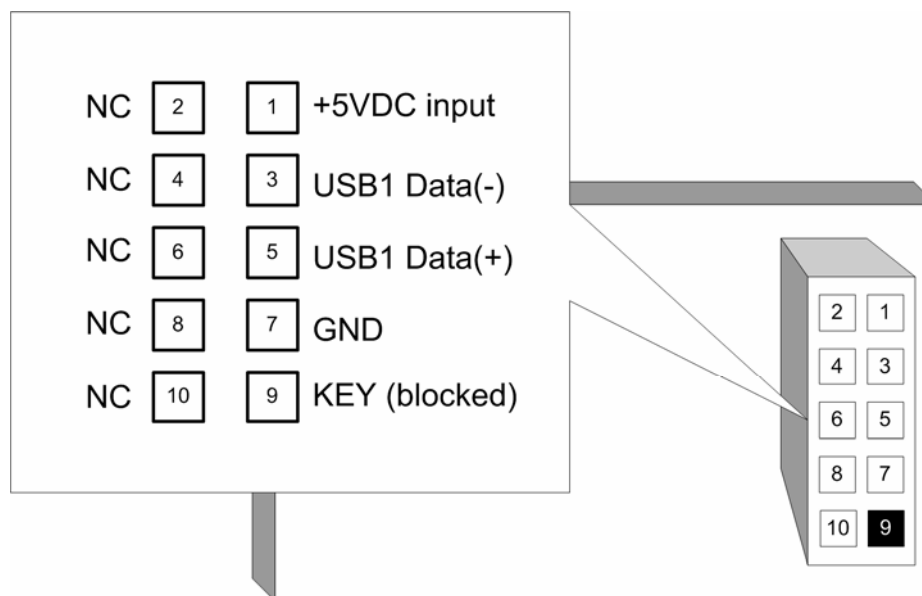
Table 1: Host Interface 2x5 On-Board Header

Pin	Signal
1	+5VDC
3	USB1 Data(-)
5	USB1 Data(+)
7	GND
9	Key (no pin)

Pin	Signal
2	+5VDC
4	USB2 Data(-)
6	USB2 Data(+)
8	GND
10	NC (future option in the Low Profile configuration: Write Protection signal)

2.2.2 uDiskOnChip Connector

Figure 1 illustrates the uDiskOnChip 2x5 device interface connector.



uDOC 2x5
(Bottom View)

Figure 1: uDiskOnChip 2x5 Connector Pinout

3. THEORY OF OPERATION

3.1 Block Diagram

The uDiskOnChip controller enables the highest performance for USB 2.0, coupled with the best security and reliability available. The controller’s firmware inherently supports multi-vendor flash components to provide flexibility and guarantee delivery to our customers.

As with other products based on M-Systems’ technology, the uDiskOnChip controller contains M-Systems’ patented USB device interface, which is compatible with USB 2.0. The controller also has a high-speed 32-bit RISC microcontroller with Idle and Deep Power-Down modes for power management.

The uDiskOnChip controller architecture is illustrated in Figure 2.

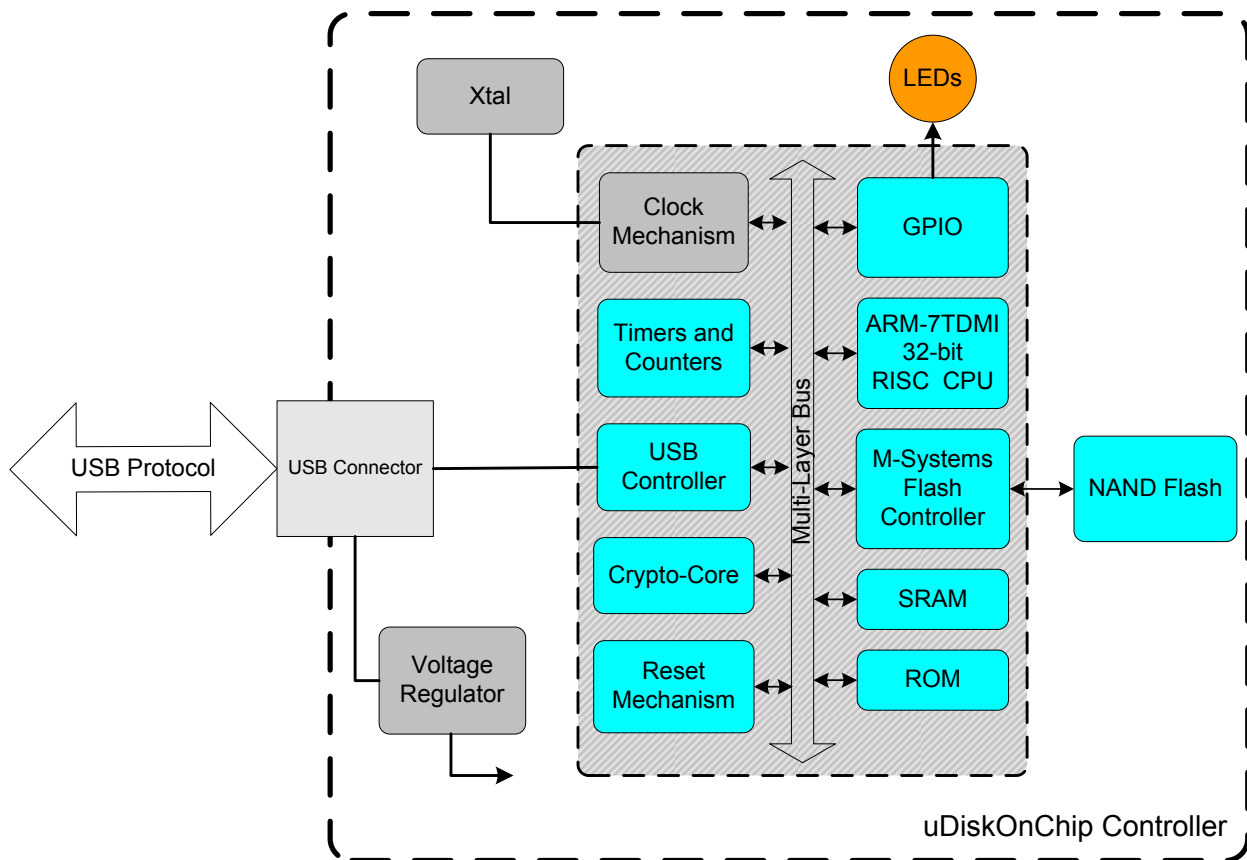


Figure 2: uDiskOnChip Controller Block Diagram

3.2 System Architecture

3.2.1 Controller Internal Components

- **ARM7TDMI CPU**, which serves as the hardware infrastructure for the M-Systems flash controller algorithm.
- **M-Systems Flash Controller**, the heart of the system, which is responsible for the flash-handling algorithm, flash timing, and Error Detection and Correction.
- **USB (PHY and Digital) Controller**, embedded in the uDiskOnChip controller, which interfaces with all external interactions via an external USB connector.
- **Crypto-Core**, the hardware engine that provides security functions and services to be used by the controller.
- **SRAM**, for running the controller program faster and more efficiently.
- **ROM**, for running the boot code and additional service program.
- **Clock Mechanism**, which drives all clock sources, some from the crystal oscillator and others from the PHY PLL.
- **Reset Mechanism**, which restores the reset states of the system, and forces the controller to perform the boot procedure. The Reset state causes all cores to move to Reset mode.
- **Timers and Counters**, including the device timer, watchdog, and general-purpose timer/counter channels.

3.2.2 Controller External Components

- **NAND Flash** for data storage.
- **Crystal Oscillator 12.000 MHz**, the main clock source.
- **3.3V Voltage Regulator** to supply a stable power supply to the circuit and for accurate and reliable operation.
- **LEDs** for indicating controller activity.

4. TRUEFFS TECHNOLOGY

4.1 Overview

M-Systems' patented TrueFFS technology was designed to maximize the benefits of flash memory while overcoming inherent flash limitations that would otherwise reduce its performance, reliability, and lifetime. TrueFFS emulates a hard disk, making flash management completely transparent to the OS.

TrueFFS, which has become an industry standard for reliability, is implemented in uDiskOnChip, therefore no integration is required.

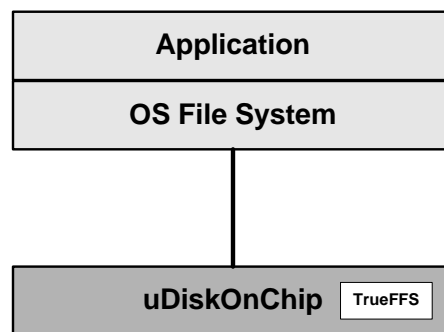


Figure 3: TrueFFS Implemented in uDiskOnChip Firmware

TrueFFS technology features:

- Flash file system management
- Bad-block management
- Dynamic virtual mapping
- Dynamic and static wear-leveling
- Power failure management
- Implementation of MLC-tailored EDC/ECC
- Performance optimization

4.2 Bad-Block Management

Since NAND flash is an imperfect storage media, it can contain bad blocks that cannot be used for storage because of their high error rates. TrueFFS automatically detects and maps out bad blocks upon system initialization, ensuring that they are not used for storage. This management process is completely transparent to the user, who is unaware of the existence and location of bad blocks, while remaining confident of the integrity of data stored.

4.3 Wear-Leveling

Flash memory can be erased a limited number of times. This number is called the *erase cycle limit*, or *write endurance limit*, and is defined by the flash array vendor. The erase cycle limit applies to each individual erase block in the flash device. In uDiskOnChip, the erase cycle limit of the flash is 100,000 erase cycles. This means that after approximately 100,000 erase cycles, the erase block begins to generate storage errors at a rate significantly higher than the error rate that is typical to the flash.

In a typical application, and especially if a file system is used, specific pages are constantly updated (e.g., the page/s that contain the FAT, registry, etc.). Without any special handling, these pages would wear out more rapidly than other pages, reducing the lifetime of the entire flash.

To overcome this inherent deficiency, TrueFFS uses M-Systems' patented wear-leveling algorithm. This wear-leveling algorithm ensures that consecutive writes of a specific sector are not written physically to the same page in the flash. This spreads flash media usage evenly across all pages, thereby maximizing flash lifetime.

M-Systems' wear-leveling mechanism provides more than 5 million write/erase cycles for reliable data storage over an extended period.

Dynamic Wear-Leveling

TrueFFS uses statistical allocation to perform dynamic wear-leveling on newly written data. This minimizes the number of erase cycles per block. As a block erase is the most time-consuming operation, dynamic wear-leveling has a major impact on overall performance. This impact cannot be noticed during the first write to flash (since there is no need to erase blocks beforehand), but becomes more and more noticeable as the flash media becomes full.

Static Wear-Leveling

Areas on the flash media may contain static files, characterized by blocks of data that remain unchanged for very long periods of time, or even for the whole device lifetime. If wear-leveling were only applied on newly written pages, static areas would never be cycled. This limited application of wear-leveling would lower life expectancy significantly in cases where flash memory contains large static areas. To overcome this problem, TrueFFS forces data transfer in static areas as well as in dynamic areas, thereby applying wear-leveling to the entire media.

4.4 Power Failure Management

TrueFFS uses algorithms based on *erase after write* instead of *erase before write* to ensure data integrity during normal operation and in the event of a power failure. Used areas are reclaimed for erasing and writing the flash management information into them only after an operation is complete. This procedure serves as a check on data integrity.

The erase-after-write algorithm is also used to update and store mapping information on the flash memory. This keeps the mapping information coherent even during power failures. The only mapping information held in RAM is a table pointing to the location of the actual mapping information. This table is reconstructed during power-up or after reset from the information stored in the flash memory.

To prevent data from being lost or corrupted, TrueFFS uses the following mechanisms:

- When writing, copying, or erasing the flash device, the data format remains valid at all intermediate stages. Previous data is never erased until the operation has been completed and the new data has been verified.
- A data sector cannot exist in a partially written state. The operation is either successfully completed, in which case the new sector contents are valid, or the operation has not yet been completed or has failed, in which case the old sector contents remain valid.

4.5 Error Detection/Correction

TrueFFS implements a unique MLC-tailored Error Correction Code (ECC) algorithm to ensure data reliability. The advanced algorithm provides 4-bit Error Detection Code/Error Correction Code (EDC/ECC), based on a patented combination of BCH and Hamming code algorithms.

5. SPECIFICATIONS

5.1 Standards Compliance

uDiskOnChip complies with CE requirements and FCC standards, and has been approved by the UL organization.

uDiskOnChip is also available in lead-free versions (all configurations), which comply with the RoHS directive.

5.2 Environmental

5.2.1 Temperature

Operating

Commercial: 0°C to +70°C

Extended: -40°C to +85°C

Storage

Extended: -55°C to +95°C

5.2.2 Electrostatic Discharge (ESD)

uDiskOnChip has been tested and approved for immunity from ESD under the conditions described in Table 2.

Table 2: ESD Ratings for uDiskOnChip

ESD Type	Maximum Discharge (KV)
Contact	1, 2, 4
Air	2, 4, 6, 8

5.2.3 Shock and Vibration

Table 3: Shock/Vibration Testing for uDiskOnChip

Reliability Test	Test Conditions	Reference Standards
Vibration	10 Hz to 500 Hz, 5 g, 3 axes, 30 minutes	IEC 68-2-6
Mechanical Shock	Duration: 11 ms, 50 g, 3 axes, 18 times	IEC 68-2-27

5.2.4 Mean Time Between Failures (MTBF)

The reliability figure of merit most often used for electronic equipment is Mean Time Between Failures (MTBF). M-Systems estimates MTBF using a prediction methodology based on reliability data for the individual components in M-Systems products.

Component data comes from several sources: device life tests, failure analysis of earlier equipment, device physics, and field returns. M-Systems uses following methods to predict reliability:

- Telcordia Special Report SR-332, Reliability Prediction Procedure for Electronic Equipment (RPP).

- British Telecom Industry HRD5, Handbook of Reliability Data for Electronic Components used in Telecommunication System.

Table 4 summarizes the MTBF prediction results for various uDiskOnChip configurations. The analysis was performed using a RAM Commander™ failure rate prediction.

- Failure Rate:** The total number of failures within an item population, divided by the total number of life units expended by that population, during a particular measurement interval under stated condition.
- Mean Time Between Failures (MTBF):** A basic measure of reliability for repairable items: The mean number of life units during which all parts of the item perform within their specified limits, during a particular measurement interval under stated conditions.

Table 4: uDiskOnChip MTBF

Product	Condition	MTBF (Hours)	Failure Rate per Million Hours
64/128MB	Telcordia SR-332, GB, 25°C	4,667,755	0.214
256/512/1024/2048MB	Telcordia SR-332, GB, 25°C	4,130,674	0.24
64/128MB	Telcordia SR-332, GF, 35°C	1,667,189	0.599
256/512/1024/2048MB	Telcordia SR-332, GF, 35°C	1,360,977	0.735

5.3 Mechanical

uDiskOnChip is offered in a horizontal version with two available configurations and in a Low Profile version, as described below. In addition, an adapter is available (described in Section 5.3.6) to enable customers to evaluate uDiskOnChip using an external USB port.

5.3.1 Horizontal - Single Connector

In the single connector configuration, uDiskOnChip has a single 2x5 electrical connector plus a mounting hole, as shown in Figure 4.



Figure 4: uDiskOnChip Horizontal Version with Single Connector

5.3.2 Horizontal - Dual Connector

In the dual connector configuration, uDiskOnChip has a 2x5 electrical connector, along with a 1x5 mechanical connector for mounting stability, as shown in Figure 5.



Figure 5: uDiskOnChip Horizontal Version with Dual Connector Configuration

5.3.3 Low Profile - Single Connector

In the low profile single connector configuration, uDiskOnChip has a single low-profile 2x5 electrical connector plus a mounting hole.

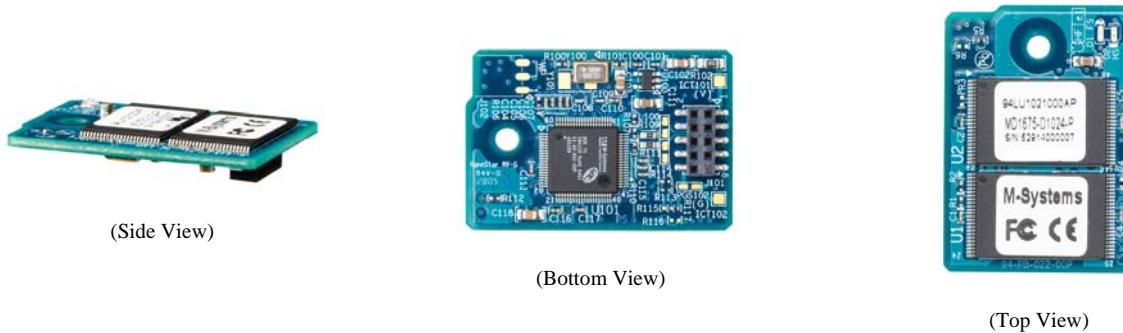


Figure 6: uDiskOnChip Horizontal Version with Single Connector

5.3.4 LED Functionality

- **LED flashing slowly:** uDiskOnChip is connected and inactive
- **LED flashing rapidly:** uDiskOnChip is transmitting/receiving data or is engaged in the identification process
- **Default LED colors:**
 - o Red: USB high-speed mode (10 MB/sec write, 20 MB/sec read)
 - o Green: USB full-speed mode (0.85 MB/sec write, 1 MB/sec read)

5.3.5 Dimensions

uDiskOnChip mechanical dimensions are in mm, with a general tolerance of ± 0.25 mm.

Horizontal Configuration

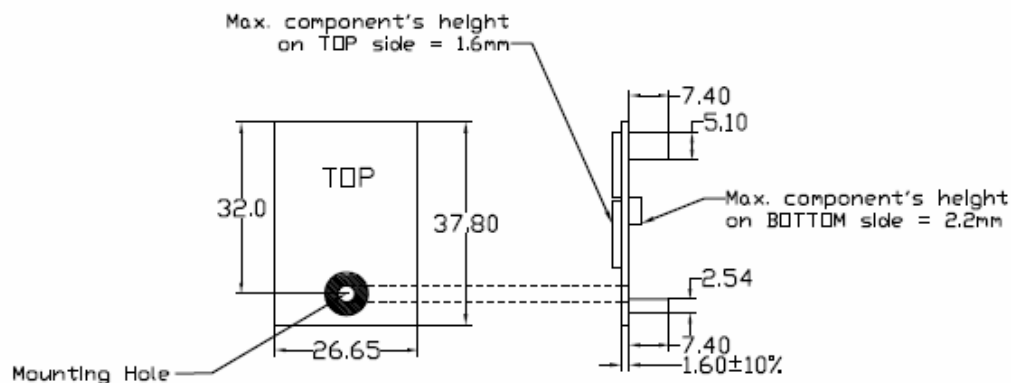


Figure 7: uDiskOnChip 2x5 Horizontal Version, Single/Dual Connector, Top View

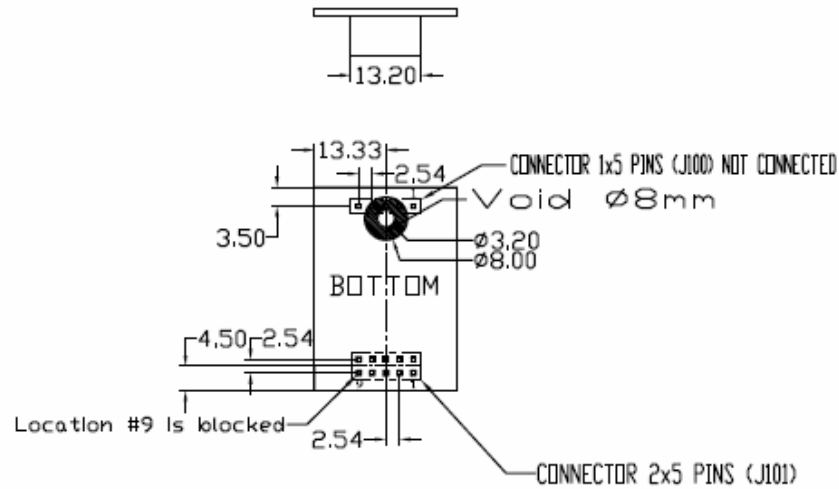


Figure 8: uDiskOnChip 2x5 Horizontal Version, Single/Dual Connector, Bottom View

Low Profile Configuration

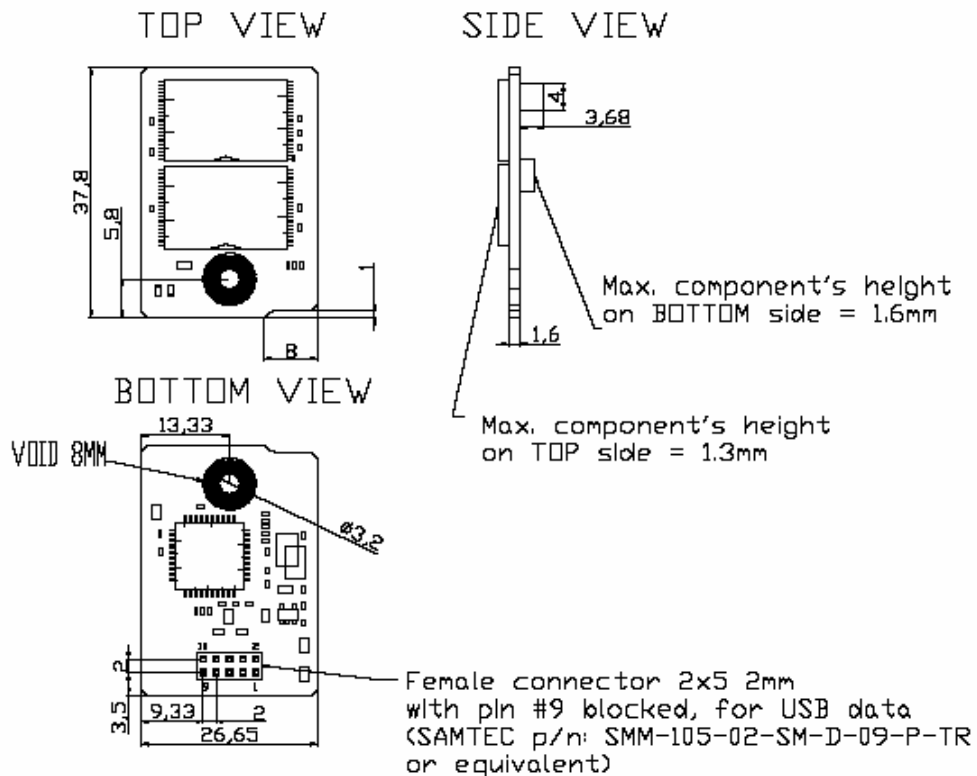


Figure 9: uDiskOnChip 2x5 Low Profile Version

5.3.6 uDiskOnChip-to-USB Adapter

An adapter is available to assist customers in evaluating uDiskOnChip. The adapter enables inserting uDiskOnChip in an external desktop or laptop USB port.



Figure 10: uDiskOnChip External USB Adapter, with and without Mounted Device

5.4 Product Markings

uDiskOnChip has two labels, one showing the part number and ordering information (Figure 11) and another showing the standards for which uDiskOnChip is certified (Figure 12).

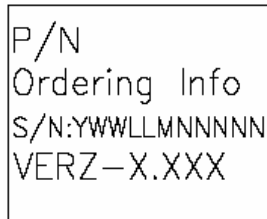


Figure 11: uDiskOnChip Part Number and Ordering Information Label

Table 5 explains the part number and ordering information printed on the uDiskOnChip label.

Table 5: Marking Specifications

Label Item	Description
P/N	Unit part number
Ordering Info	Unit ordering information
S/N:YWWLLMNNNNN	Unit serial number
VERZ – X.XXX	Z – Bill Of Material (BOM) revision X.XXX – Firmware version



Figure 12: uDiskOnChip Standards Label

5.5 Electrical Specifications

5.5.1 Absolute Maximum Ratings

Table 6: Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Ambient Operating Temperature Range (Commercial)	T_A	0	70	°C
Ambient Operating Temperature Range (Extended)	T_A	-40	85	°C
Power Supply Voltage Relative to Ground	V_{bus}	4	6	V
Voltage level on D+ / D- Relative to Ground 3	V_{data}	-1	4.6	V

5.5.2 DC Characteristics

Table 7: DC Characteristics for Full-Speed Operation ($T_A = 25^\circ\text{C}$, $V_{DD} = 3.3\text{v}$, $V_{SS} = 0\text{V}$)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
USB Signals						
Supply Voltage:	V_{BUS}		4.40	5.00	5.25	V
Supply Current (RMS):			--			
Operating	I_{CC}	VBUS=5.0v	--	87	100	mA
Suspend	I_{CCS}			<500	<500	µA
Max Current Consumption (Peak Value)					105	mA
Input Levels USB Signals (D+, D-):						
Low	V_{IL}	--	--	--	0.8	V
High	V_{IH}	--	2.0	--	--	V
Output Voltage USB Signals (D+, D-):						
Low	V_{OL}	R_L of 1.5 kΩ to 3.6V	0	--	0.4	V
High	V_{OH}	R_L of 15 kΩ to GND	2.6	--	3.6	V
Output Signal Crossover Voltage USB Signals (D+, D-)	V_{CRS}		1.3		2.0	V

Table 8: DC Characteristics for High-Speed Operation ($T_A = 25^\circ\text{C}$, $V_{DD} = 3.3\text{V}$, $V_{SS} = 0\text{V}$)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
USB Signals						
Supply Voltage:	V _{BUS}		4.40	5.00	5.25	V
Supply Current (RMS)			--			
Operating	I _{cc}	V _{BUS} =5.0v	--	100	120	mA
Suspend	I _{ccs}			<500	<500	μA
Max Current Consumption (Peak Value)					150	mA
Input Levels USB Signals (D+, D-):						
Low	V _{IL}	--	--	--	0.8	V
High	V _{IH}	--	2.0	--	--	V
Output Voltage USB Signals (D+, D-):						
Low	V _{OL}	R _L of 1.5 kΩ to 3.6V	0	--	0.4	V
High	V _{OH}	R _L of 15 kΩ to GND	2.6	--	3.6	V
Output Signal Crossover Voltage USB Signals (D+, D-):	V _{CRS}		1.3		2.0	V

6. SOFTWARE DESCRIPTION

6.1 Boot and Storage

uDiskOnChip is supported under the embedded operating systems listed in Table 9. In the standard boot and storage modes, uDiskOnChip is recognized as a hard drive in the system. The system can also boot from uDiskOnChip, eliminating the need for additional components.

Software packages for the supported operating systems can be downloaded from the M-Systems website, along with the relevant documentation.

Table 9: Supported Operating Systems

Operating System	Version	Application Note
Windows XP Embedded	Service Pack 2	AP-DOC-1304, <i>Booting Windows XP Embedded from uDiskOnChip</i>
Windows Embedded for Point of Service (WEPOS)	N/A	AP-EMB-0305, <i>Creating a WEPOS Image with Support for USB Mass Storage Devices</i>
Windows CE	4.2 and 5.0	AP-EMB-0105, <i>Creating a Windows CE Image with Support for USB Mass Storage Devices</i>
Linux	All versions	AP-DOC-0105, <i>Booting Trustix/Fedora (Kernel 2.4.XX/2.6XX) from uDiskOnChip</i>
VxWorks	5.x and 6.1	AP-EMB-0205, <i>Creating a VxWorks Image with Support for USB Mass Storage Devices</i>

6.2 Secure Boot and Storage

Secure Boot is supported by Microsoft Windows XP Embedded only. Secure Boot mode provides uDiskOnChip customers with the advantage of M-Systems' security capabilities, which implement unparalleled security algorithms in hardware using SuperMAP technology. M-Systems' security technology is supported by over 15 patents, and field tested in tens of millions of smartcards.

Some customization may be required to set uDiskOnChip and the host to work in Secure Boot mode. M-Systems' technical support department can provide a software package, including all required user manuals, for use in configuring uDiskOnChip to function as a secure system boot device.

In Secure Boot mode, uDiskOnChip can be partitioned into up to six drives, with a maximum of two secure drives and four standard drives. The secure drives are write protected using Public Key Infrastructure (PKI) for key exchange and authentication (implemented by an RSA 64-byte key). In addition, uDiskOnChip supports the Enhanced Write Filter (enabling Microsoft EWF).

It is recommended to partition uDiskOnChip as follows when using Secure Boot mode:

- Secure partition I: This drive stores the Windows XP Embedded operating system image.
- Secure partition II (optional): This drive can function as a secure storage area for data that should not be accessed by unauthorized users
- Standard partition: Up to four standard drives that are not write protected

7. ORDERING INFORMATION

7.1 uDiskOnChip

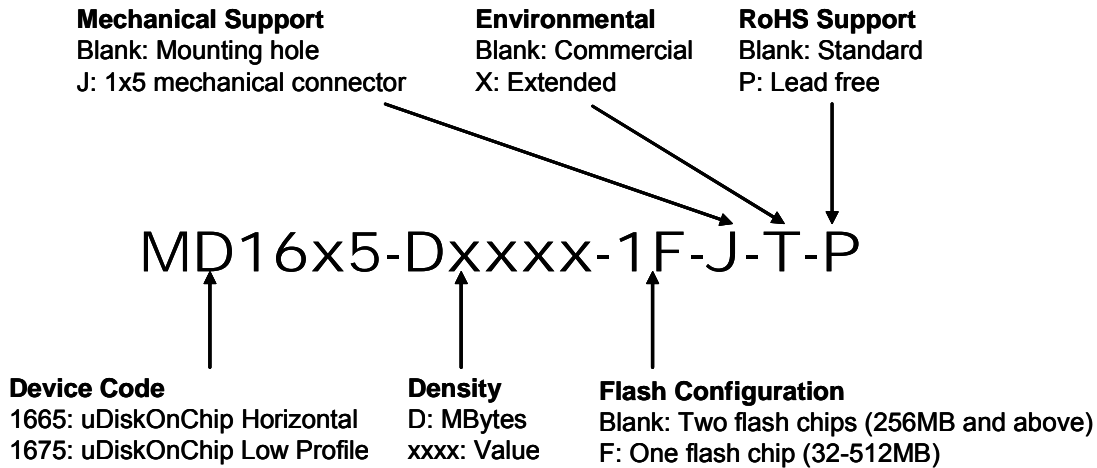


Figure 13: Ordering Information Structure

Table 10: uDiskOnChip Form Factors and Ordering Information

Configuration	Temperature Range	Capacity (MB)	Ordering Information
Horizontal with single connector and mounting hole (PB Free Version)	Commercial	32	MD1665-D32-P
		64	MD1665-D64-P
		128	MD1665-D128-P
		256	MD1665-D256-P
		512	MD1665-D512-P
		1024	MD1665-D1024-P
		2048	MD1665-D2048-P
	Extended	32	MD1665-D32-X-P
		64	MD1665-D64-X-P
		128	MD1665-D128-X-P
		256	MD1665-D256-X-P
		512	MD1665-D512-X-P
		1024	MD1665-D1024-X-P
		2048	MD1665-D2048-X-P
Single-flash horizontal configuration with single connector and mounting hole (PB-free version)	Commercial	256	MD1665-D256-1F-P
		512	MD1665-D512-1F-P
		1024	MD1665-D1024-1F-P
		2048	MD1665-D2048-1F-P
	Extended	256	MD1665-D256-1F-X-P

Configuration	Temperature Range	Capacity (MB)	Ordering Information
		512	MD1665-D512-1F-X-P
		1024	MD1665-D1024-1F-X-P
		2048	MD1665-D2048-1F-X-P
Horizontal configuration with dual connector (PB-free version)	Commercial	32	MD1665-D32-J-P
		64	MD1665-D64-J-P
		128	MD1665-D128-J-P
		256	MD1665-D256-J-P
		512	MD1665-D512-J-P
		1024	MD1665-D1024-J-P
		2048	MD1665-D2048-J-P
	Extended	4096	MD1665-D4096-J-P
		32	MD1665-D32-J-X-P
		64	MD1665-D64-J-X-P
		128	MD1665-D128-J-X-P
		256	MD1665-D256-J-X-P
		512	MD1665-D512-J-X-P
		1024	MD1665-D1024-J-X-P
2048	MD1665-D2048-J-X-P		
Single-flash horizontal configuration with dual connector (PB-free version)	Commercial	256	MD1665-D256-1F-J-P
		512	MD1665-D512-1F-J-P
		1024	MD1665-D1024-1F-J-P
	Extended	2048	MD1665-D2048-1F-J-P
		256	MD1665-D256-1F-J-X-P
		512	MD1665-D512-1F-J-X-P
		1024	MD1665-D1024-1F-J-X-P
2048	MD1665-D2048-1F-J-X-P		
Low Profile configuration with single connector and mounting hole (PB-free version)	Commercial	32	MD1675-D32-P
		64	MD1675-D64-P
		128	MD1675-D128-P
		256	MD1675-D256-P
		512	MD1675-D512-P
		1024	MD1675-D1024-P
		2048	MD1675-D2048-P
	Extended	4096	MD1675-D4096-P
		32	MD1675-D32-X-P
		64	MD1675-D64-X-P
		128	MD1675-D128-X-P
		256	MD1675-D256-X-P
		512	MD1675-D512-X-P
		1024	MD1675-D1024-X-P

Configuration	Temperature Range	Capacity (MB)	Ordering Information
		2048	MD1675-D2048-X-P
		4096	MD1675-D4096-X-P
Single-flash low profile configuration (PB-free version)	Commercial	256	MD1675-D256-1F-P
		512	MD1675-D512-1F-P
		1024	MD1675-D1024-1F-P
		2048	MD1675-D2048-1F-P
	Extended	256	MD1675-D256-1F-X-P
		512	MD1675-D512-1F-X-P
		1024	MD1675-D1024-1F-X-P
		2048	MD1675-D2048-1F-X-P
Low Profile configuration with external LED support (PB-free version)	Commercial	1024	MD1675-D1024-1F-P-V1
		2048	MD1675-D2048-1F-P-V1

7.2 uDiskOnChip-to-USB Adapter

Ordering information for the uDiskOnChip-to-USB adapter: UDOC-2X5-ADPT-P

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